Inventor: Henry Johnson Serial No.: 09/752,658

Attny Dkt. No. H0001540 (4960)

Art Unit: 2827
Examiner: David Graybill

## VERSIONS WITH MARKING TO SHOW CHANGES MADE

## In the Claims

1. A sublamination material, comprising:

- a conductive single layer reference plane having a top surface and a bottom surface;
- a <u>conductive</u> first signal layer coupled to the top surface with a <u>cured</u> core material, the <u>first signal layer having an exposed surface opposite a surface coupled to the reference plane;</u>
- a <u>conductive</u> second signal layer coupled to the bottom surface with a <u>cured</u> bond-ply material, the second signal layer having an exposed surface opposite a surface coupled to the reference plane; and

at least one of a blind via or a micro via; wherein

the reference plane, first signal layer, and second signal layer are three separate layers.

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